

## PATENT ASSIGNMENT COVER SHEET

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| <b>SUBMISSION TYPE:</b>   | NEW ASSIGNMENT                   |
| <b>NATURE OF CONVEYANCE:</b>  | ASSIGNMENT                       |
| <b>CONVEYING PARTY DATA</b>   |                                  |
| <b>Name</b>   | <b>Execution Date</b>            |
| TAKAYA OCHIAI   | 12/12/2016                       |
| TAKESHI AKAI  | 12/12/2016                       |
| IKUHISA OKAMOTO   | 12/12/2016                       |
| TAKEHISA SHIMAZU  | 12/14/2016                       |
| YOUHEI NIITSUMA   | 12/12/2016                       |
| <b>RECEIVING PARTY DATA</b>   |                                  |
| <b>Name:</b>  | RICOH COMPANY, LTD.              |
| <b>Street Address:</b>  | 3-6, NAKAMAGOME 1-CHOME, OHTA-KU |
| <b>City:</b>  | TOKYO                            |
| <b>State/Country:</b>   | JAPAN                            |
| <b>Postal Code:</b>   | 143-8555                         |
| <b>PROPERTY NUMBERS Total: 1</b>  |                                  |
| <b>Property Type</b>  | <b>Number</b>                    |
| <b>Application Number:</b>  | 15384199                         |
| <b>CORRESPONDENCE DATA</b>  |                                  |
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| <b>Email:</b>   | mail@dbflaw.com                  |
| <b>Correspondent Name:</b>  | DUFT BORNSSEN & FETTIG LLP       |
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| <b>ATTORNEY DOCKET NUMBER:</b>  | FN201608369                      |
| <b>NAME OF SUBMITTER:</b>   | BRETT BORNSSEN                   |
| <b>SIGNATURE:</b>   | /BRETT BORNSSEN/                 |
| <b>DATE SIGNED:</b>   | 12/20/2016                       |
| <b>Total Attachments: 3</b>   |                                  |
| source=FN201608369-US-ASSIGNMENT#page1.tif  |                                  |
| source=FN201608369-US-ASSIGNMENT#page2.tif  |                                  |



# A S S I G N M E N T

Docket No.  
Page 1 of 2

WHEREAS, I/we TAKAYA OCHIAI of 810, Shimoimaizumi, Ebina-shi, Kanagawa, 243-0435, Japan; TAKESHI AKAI of KANAGAWA, JAPAN; IKUHISA OKAMOTO of KANAGAWA, JAPAN; TAKEHISA SHIMAZU of KANAGAWA, JAPAN; YOUHEI NIITSUMA of 810, Shimoimaizumi, Ebina-shi, Kanagawa, 243-0435, Japan;

have invented certain improvements in

**SOUND ABSORBER, SHEET FEEDER INCORPORATING THE SOUND ABSORBER, IMAGE READING DEVICE INCORPORATING THE SHEET FEEDER, IMAGE FORMING APPARATUS INCORPORATING THE SOUND ABSORBER, AND ELECTRONIC DEVICE INCORPORATING THE SOUND ABSORBER**

and have executed a United States patent application therefore;

AND WHEREAS, RICOH COMPANY, LTD., a corporation organized under the laws of JAPAN, having an address at 3-6, Nakamagome 1-chome, Ohta-ku, Tokyo 143-8555, Japan is desirous of acquiring the entire right, title and interest in the said application including any continuations, continuations-in-part, divisions, reissues, re-examinations or extensions thereof, and in and to any and all patents of the United States and foreign countries which may be issued for said invention;

NOW THEREFORE, for good and valuable consideration, receipt for and sufficiency of which is hereby acknowledged, I, an above named inventor, hereby sell, assign, transfer, and set over unto RICOH COMPANY, LTD., its legal representatives, successors and assigns, the entire right, title and interest in and to said invention as set forth in the above-mentioned application, including any continuations, continuations-in-part, divisions, reissues, re-examinations or extensions thereof, and in and to any and all patents of the United States and foreign countries which may be issued for said invention;

UPON SAID CONSIDERATIONS, I hereby agree with RICOH COMPANY, LTD. that I will not execute and writing or do any act whatsoever conflicting with these presents, and that I will, at any time upon request, without further or additional consideration but at the expense of said RICOH COMPANY, LTD., execute such additional assignments and other writings and do such additional acts as said RICOH COMPANY, LTD. may deem necessary or desirable to perfect RICOH COMPANY, LTD. enjoyment of this grant, and render all necessary assistance in making application for and obtaining original, divisional, continuation, continuations-in-part, re-examination, reissued, or extended Letter Patent of the United States or any and all foreign countries on said invention, and in enforcing any rights or choses in action accruing as a result of such applications or patents, and by executing preliminary statements and other affidavits, it being understood that the foregoing covenant and agreement shall bind, and inure to the benefit of the assigns and legal representative of assignor and RICOH COMPANY, LTD.;

AND I request the Commissioner of Patents and Trademarks to issue any Letter Patent of the United States which may be issued for said invention to RICOH COMPANY, LTD., its legal representatives, successors or assigns, as the sole owners of the entire right, title and interest in and to said patent and the invention covered thereby.

Signed

Takaya Ochiai SIGNATURE  
on December 12, 2016, TAKAYA OCHIAI INVENTOR

Takeshi Akai SIGNATURE  
on December 12, 2016, TAKESHI AKAI INVENTOR

Ikuhisa Okamoto SIGNATURE  
on December 12, 2016, IKUHISA OKAMOTO INVENTOR

\_\_\_\_\_  
on \_\_\_\_\_, 20\_\_\_\_, TAKEHISA SHIMAZU SIGNATURE  
INVENTOR

Youhei Niitsuma SIGNATURE  
on December 12, 2016, YOUHEI NIITSUMA INVENTOR

Signed

on \_\_\_\_\_, 20\_\_, TAKAYA OCHIAI SIGNATURE  
INVENTOR

on \_\_\_\_\_, 20\_\_, TAKESHI AKAI SIGNATURE  
INVENTOR

on \_\_\_\_\_, 20\_\_, IKUHISA OKAMOTO SIGNATURE  
INVENTOR

on *Takehisa Shimazu*  
*December 14, 2016* TAKEHISA SHIMAZU SIGNATURE  
INVENTOR

on \_\_\_\_\_, 20\_\_, YOUHEI NIITSUMA SIGNATURE  
INVENTOR